

L Number	Hits	Search Text	DB	Time stamp
1	2	5941761.pn.	USPAT; EPO; JPO; DERWENT; IBM TDB USPAT; EPO; JPO; DERWENT; IBM TDB USPAT; EPO; JPO; DERWENT; IBM TDB	2004/10/01 08:05
2	46	(CMP or "chemical mechanical polishing") and (pad same effector) and friction\$3	USPAT; EPO; JPO; DERWENT; IBM TDB USPAT; EPO; JPO; DERWENT; IBM TDB USPAT; EPO; JPO; DERWENT;	2004/10/01 08:23
3	35188	CMP or "chemical mechanical polishing"	IBM TDB USPAT; EPO; JPO; DERWENT; IBM TDB USPAT; EPO; JPO; DERWENT;	2004/10/01 09:02
4	104	(CMP or "chemical mechanical polishing") and (pad same effector)	IBM TDB USPAT; EPO; JPO; DERWENT; IBM TDB USPAT; EPO; JPO; DERWENT;	2004/10/01 09:02
5	133	pad and effector and condition\$4 and CMP	IBM TDB USPAT; EPO; JPO; DERWENT; IBM TDB USPAT; EPO; JPO; DERWENT;	2004/10/01 09:03
6	1264	pad and effector and condition\$4	IBM TDB USPAT; EPO; JPO; DERWENT; IBM TDB USPAT; EPO; JPO; DERWENT;	2004/10/01 09:07
7	142	(CMP or "chemical mechanical polishing") and (pad and effector and condition\$4)	IBM TDB USPAT; EPO; JPO; DERWENT; IBM TDB USPAT; EPO; JPO; DERWENT;	2004/10/01 09:04
8	2086	((438/691) or (438/692) or (438/693)).CCLS.	IBM TDB USPAT; EPO; JPO; DERWENT; IBM TDB USPAT; EPO; JPO; DERWENT;	2004/10/01 09:05
9	17	((438/691) or (438/692) or (438/693)).CCLS.) and (pad and effector and condition\$4)	IBM TDB USPAT; EPO; JPO; DERWENT; IBM TDB USPAT; EPO; JPO; DERWENT;	2004/10/01 09:05
10	3097	((451/41) or (451/56) or (451/72)).CCLS.	IBM TDB USPAT; EPO; JPO; DERWENT; IBM TDB USPAT; EPO; JPO; DERWENT;	2004/10/01 09:07
11	71	(((451/41) or (451/56) or (451/72)).CCLS.) and (pad and effector and condition\$4)	IBM TDB USPAT; EPO; JPO; DERWENT; IBM TDB USPAT; EPO; JPO; DERWENT;	2004/10/01 09:07
12	1767	(pad or cloth) and effector	IBM TDB USPAT; EPO; JPO; DERWENT; IBM TDB USPAT; EPO; JPO; DERWENT;	2004/10/01 09:07
13	73	(((451/41) or (451/56) or (451/72)).CCLS.) and ((pad or cloth) and effector)	IBM TDB USPAT; EPO; JPO; DERWENT; IBM TDB	2004/10/01 09:07